



CEPC vertex Detector

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Ref-TDR

- More than 50 pages ready (85%)
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- Introduction part (ready)
- R & D part
 - Jadepix/Taichu (1st draft ready)
 - Stitching (just upload)
- Detector design
 - Physics Layout (1st draft ready)
 - Stitching design (1st draft ready)
 - Mechanics (1st draft ready)

<https://latex.ihep.ac.cn/project/6745179fef5108a66841008a>

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International collaboration

- ALICE international managements team visited China this week
 - Visit IHEP in Thursday
 - Potential collaboration in stitching of vertex detector in ALICE3 upgrade